

PJQ5426

30V N-Channel Enhancement Mode MOSFET

Voltage

30 V

Current

115A

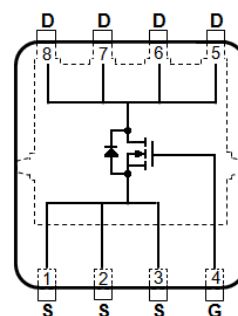
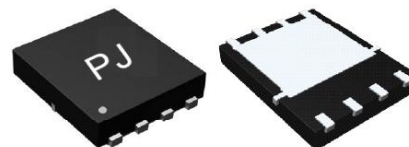
Features

- $R_{DS(ON)}$, $V_{GS}@10V, I_D@20A < 2.4m\Omega$
- $R_{DS(ON)}$, $V_{GS}@4.5V, I_D@15A < 3.3m\Omega$
- High switching speed
- Improved dv/dt capability
- Low Gate Charge
- Low reverse transfer capacitance
- Lead free in compliance with EU RoHS2.0 (2011/65/EU & 2015/865/EU directive)
- Green molding compound as per IEC61249 Std.. (Halogen Free)

Mechanical Data

- Case: DFN5060-8L Package
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.0028 ounces, 0.08 grams

DFN5060-8L



Maximum Ratings and Thermal Characteristics ($T_A=25^{\circ}C$ unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current	$T_C=25^{\circ}C$	I_D	115	A
	$T_C=100^{\circ}C$		73	
Pulsed Drain Current ^(Note 1)	$T_C=25^{\circ}C$	I_{DM}	460	
Power Dissipation	$T_C=25^{\circ}C$	P_D	136	W
	$T_C=100^{\circ}C$		54	
Continuous Drain Current	$T_A=25^{\circ}C$	I_D	20	A
	$T_A=70^{\circ}C$		16	
Power Dissipation	$T_A=25^{\circ}C$	P_D	2.0	W
Power Dissipation	$T_A=70^{\circ}C$		1.3	
Single Pulse Avalanche Energy ^(Note 6)		E_{AS}	180	mJ
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55~150	$^{\circ}C$
Typical Thermal resistance ^(Note 4,5)	Junction to Case	$R_{\theta JC}$	0.92	$^{\circ}C/W$
	Junction to Ambient	$R_{\theta JA}$	62.5	

- Limited only By Maximum Junction Temperature



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Electrical Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

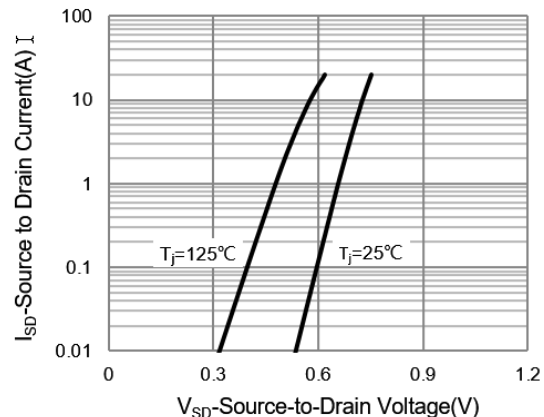
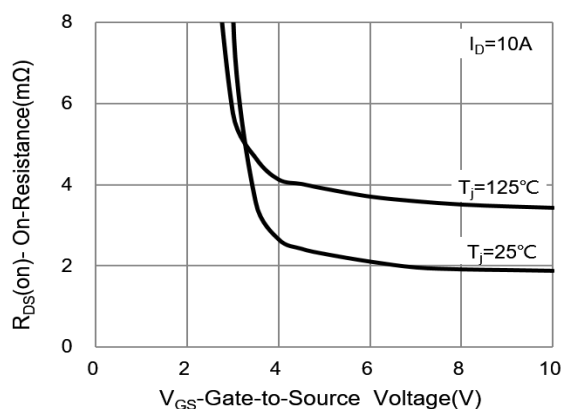
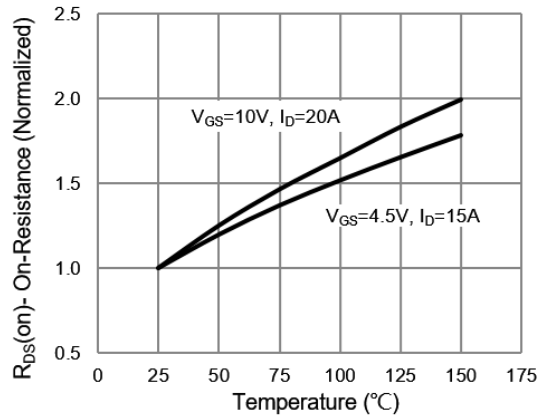
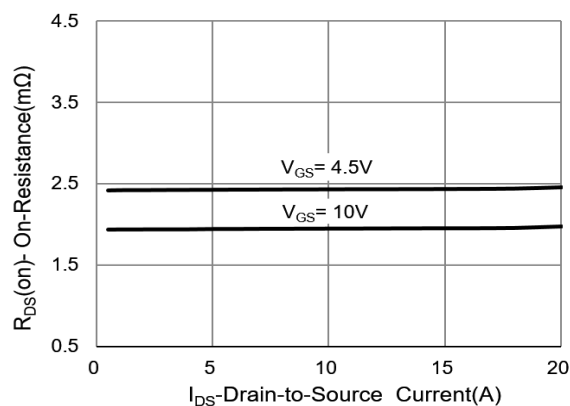
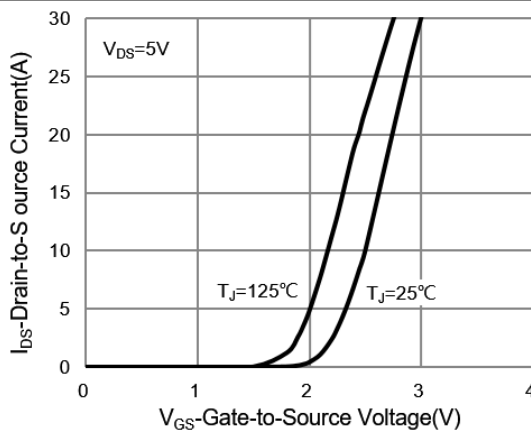
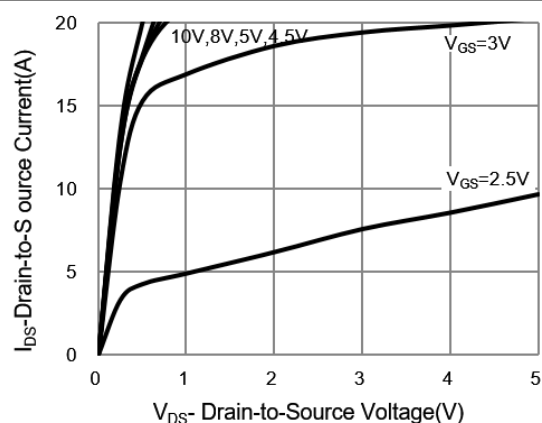
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	30	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1	1.6	2.5	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A	-	1.9	2.4	mΩ
		V _{GS} =4.5V, I _D =15A	-	2.3	3.3	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V	-	-	1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Dynamic (Note 7)						
Total Gate Charge	Q _g	V _{DS} =15V, I _D =24A, V _{GS} =4.5V (Note 2,3)	-	35	-	nC
Gate-Source Charge	Q _{gs}		-	13	-	
Gate-Drain Charge	Q _{gd}		-	10	-	
Input Capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f=1.0MHZ	-	4305	-	pF
Output Capacitance	C _{oss}		-	617	-	
Reverse Transfer Capacitance	C _{rss}		-	310	-	
Turn-On Delay Time	td _(on)	V _{DS} =15V, I _D =1A, V _{GS} =10V, R _G =1Ω (Note 2,3)	-	13	-	ns
Turn-On Rise Time	t _r		-	14	-	
Turn-Off Delay Time	td _(off)		-	46	-	
Turn-Off Fall Time	t _f		-	32	-	
Drain-Source Diode						
Maximum Continuous Drain-Source Diode Forward Current	I _S	---	-	-	115	A
Diode Forward Voltage	V _{SD}	I _S =1A, V _{GS} =0V	-	0.66	1	V

NOTES:

1. Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$
2. Essentially independent of operating temperature typical characteristics
3. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}=150^{\circ}\text{C}$. Ratings are based on low frequency and duty cycles to keep initial $T_J=25^{\circ}\text{C}$.
4. The maximum current rating is package limited
5. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
6. The test condition is $L=0.1\text{mH}$, $I_{AS}=60A$, $V_{DD}=25V$, $V_{GS}=10V$
7. Guaranteed by design, not subject to production testing

PJQ5426

TYPICAL CHARACTERISTIC CURVES



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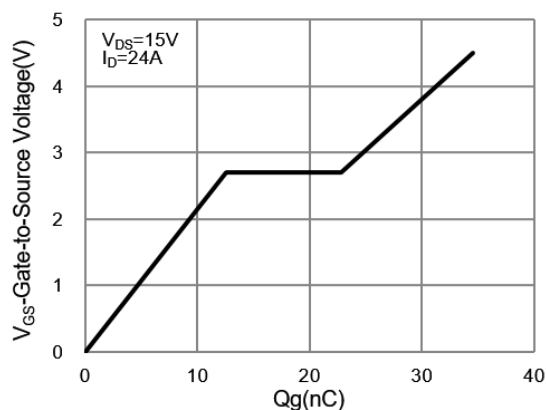


Fig.7 Gate-Charge Characteristics

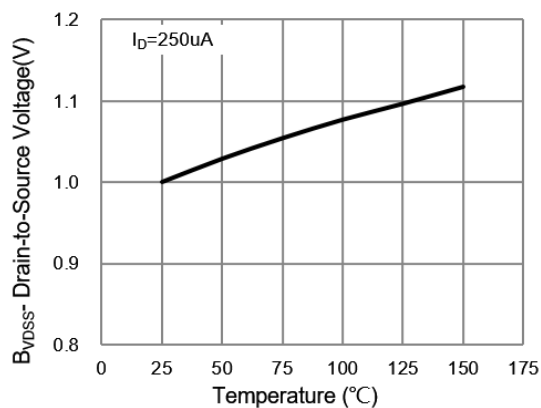


Fig.8 Breakdown Voltage Variation vs. Temperature

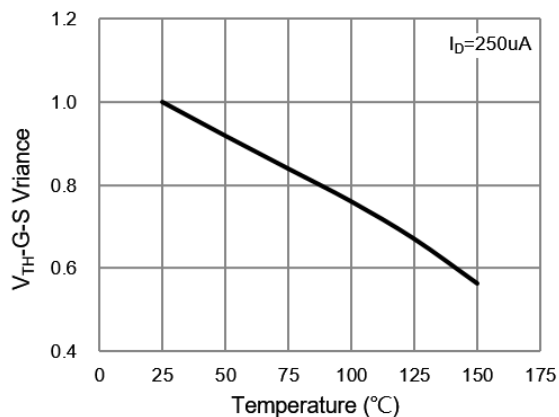


Fig.9 Threshold Voltage Variation with Temperature.

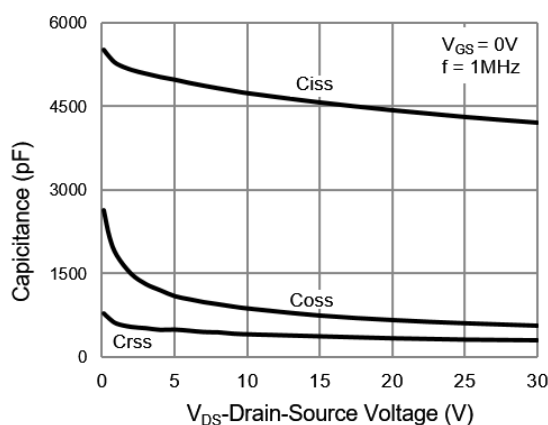


Fig.10 Capacitance vs. Drain-Source Voltage.

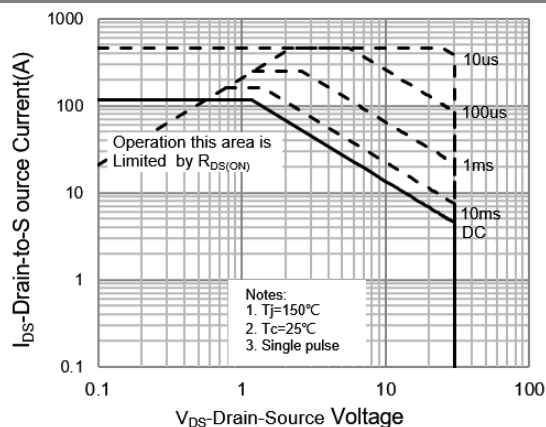


Fig.11 Maximum Safe Operating Area



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TYPICAL CHARACTERISTIC CURVES

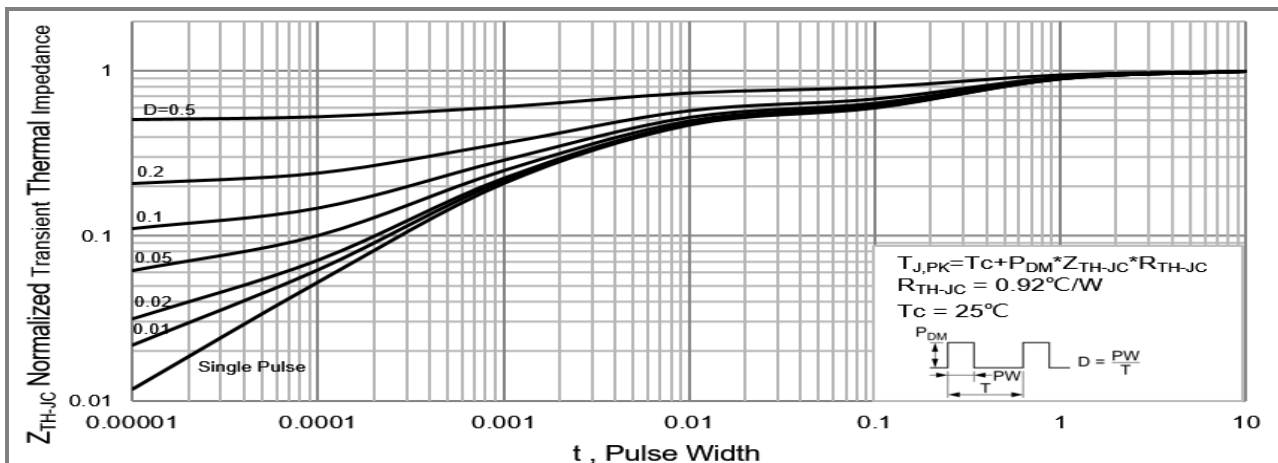


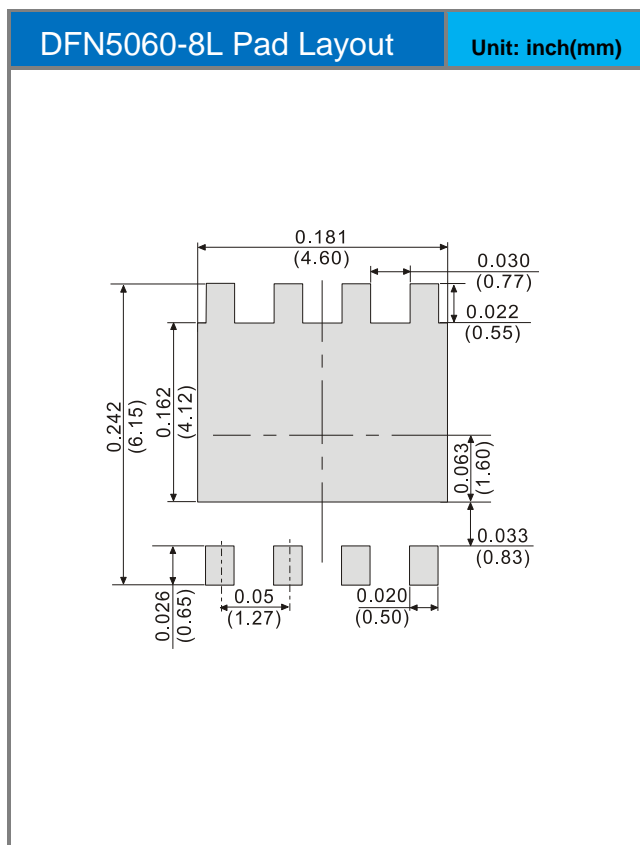
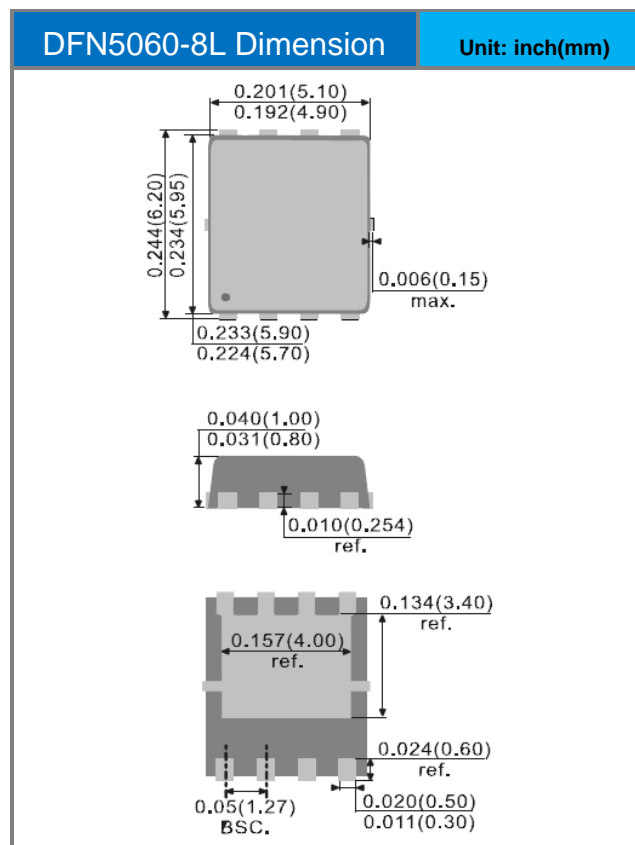
Fig.12 Normalized Transient Thermal Impedance vs. Pulse Width

PJQ5426

Part No Packing Code Version

Part No Packing Code	Package Type	Packing Type	Marking	Version
PJQ5426_R2_00001	DFN5060-8L	3000pcs / 13" reel	Q5426	Halogen free

Packaging Information & Mounting Pad Layout





PJQ5426

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